Electronic Acknowledgement Receipt			
EFS ID:	1429519		
Application Number:	10055266		
International Application Number:			
Confirmation Number:	6747		
Title of Invention:	Semiconductor package having changed substrate design using special wire bonding		
First Named Inventor/Applicant Name:	Ki-won Choi		
Customer Number:	20575		
Filer:	Alexander Charles Johnson/Li mei Vermilya		
Filer Authorized By:	Alexander Charles Johnson		
Attorney Docket Number:	9898-208		
Receipt Date:	10-JAN-2007		
Filing Date:	22-JAN-2002		
Time Stamp:	15:43:19		
Application Type:	Utility		

Payment information:

Submitted with Payment	no		
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1		9898-208h.pdf	1153763	yes	17

	Multipart Description/PDF lifes in .zip description			
	Document Description	Start	End	
	Miscellaneous Incoming Letter	1	1	
	Amendment After Final	2	7	
	Applicant Arguments/Remarks Made in an Amendment	8	11	
	Drawings	12	17	
Warnings:				

Multipart Description/DDE files in via description

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

Total Files Size (in bytes):

1153763

New Applications Under 35 U.S.C. 111

Information:

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.